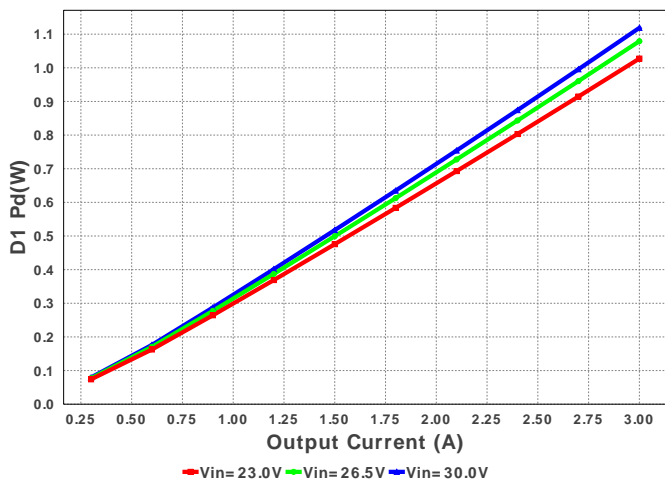
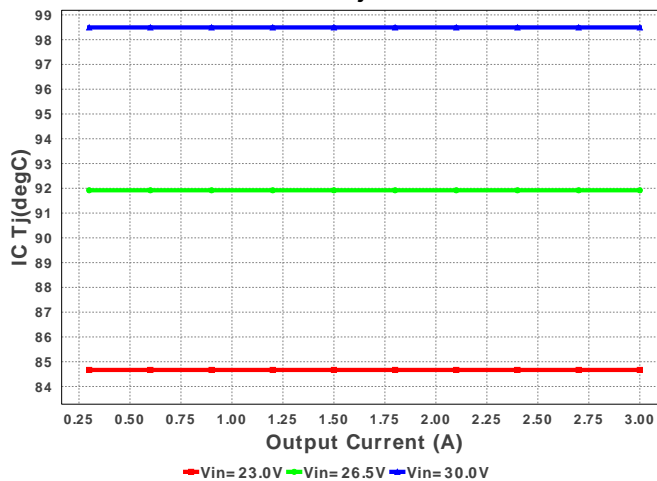


#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
9.	Rfb1	Vishay-Dale	CRCW040210K0FKED Series= CRCW..e3	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
10.	Rfb2	Vishay-Dale	CRCW040238K3FKED Series= CRCW..e3	Res= 38.3 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
11.	Rsns	Stackpole Electronics Inc	CSR1206FK20L0 Series= ?	Res= 20.0 mOhm Power= 500.0 mW Tolerance= 1.0%	1	\$0.10	1206 11 mm ²
12.	U1	Texas Instruments	LM3485MM/NOPB	Switcher	1	\$0.52	MUA08A 24 mm ²

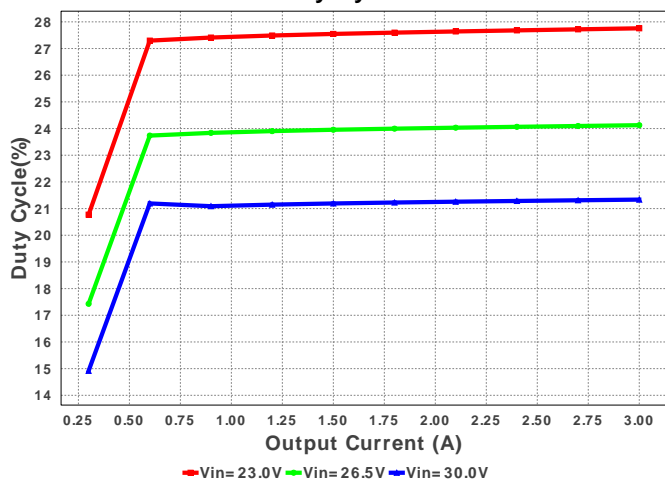
D1 Pd



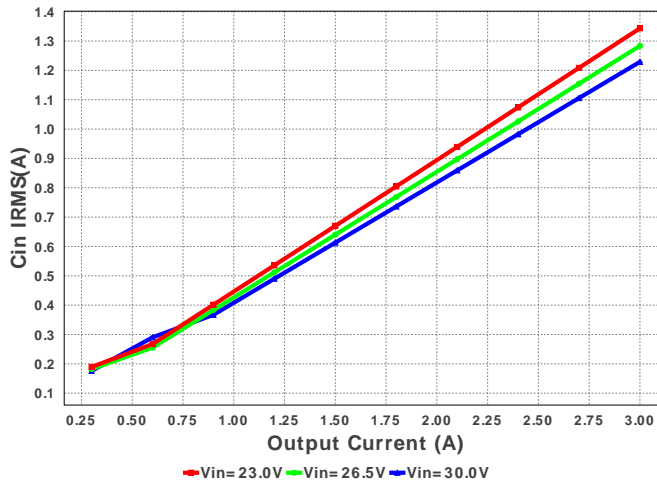
IC Tj

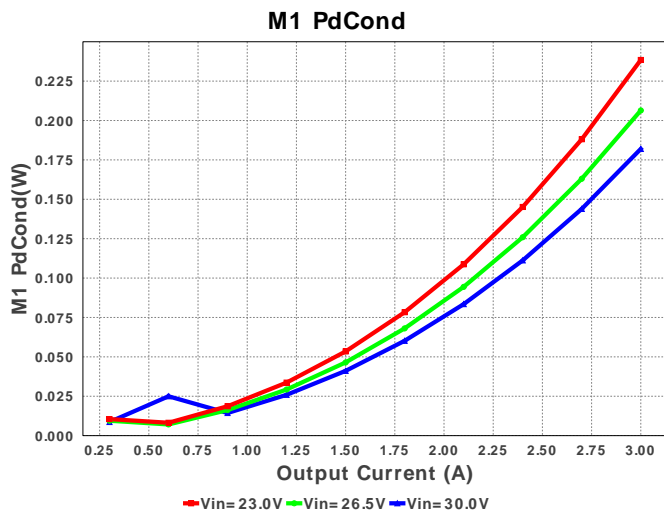
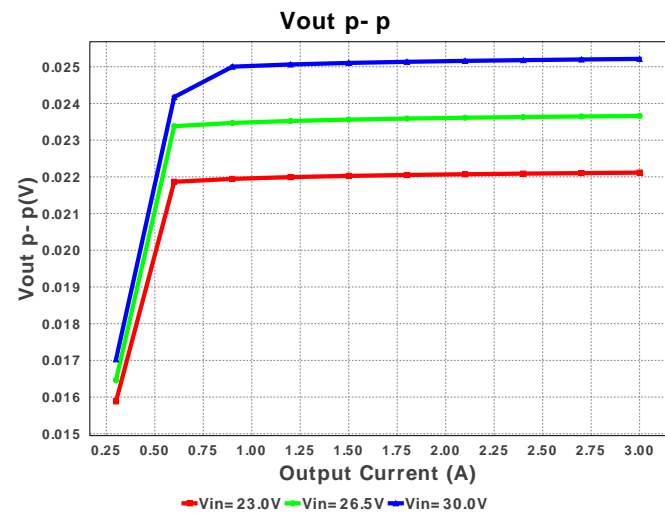
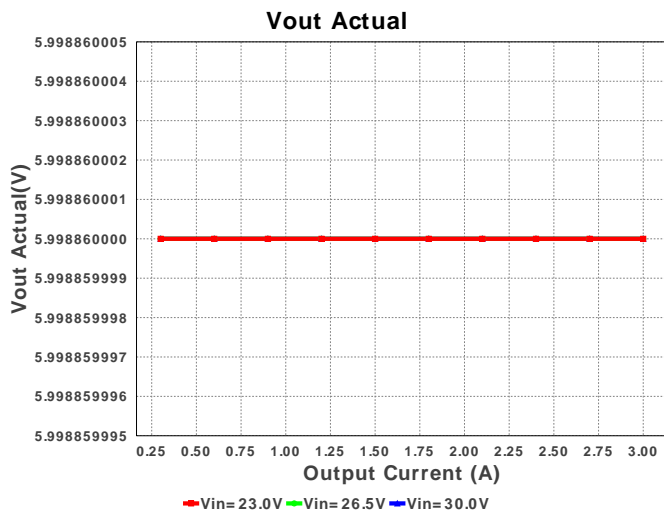
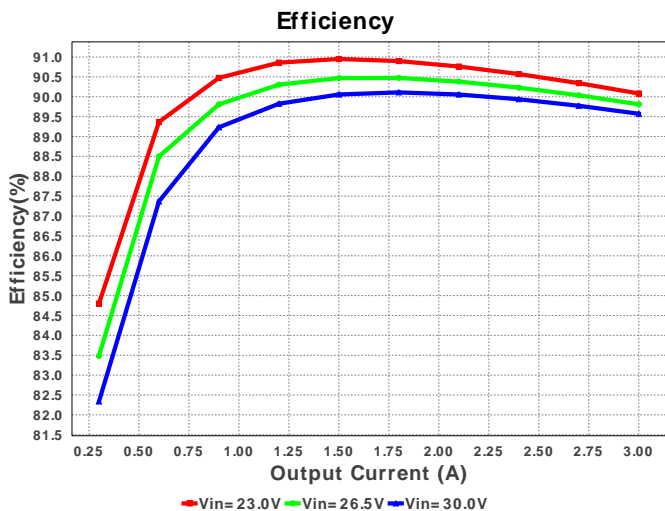
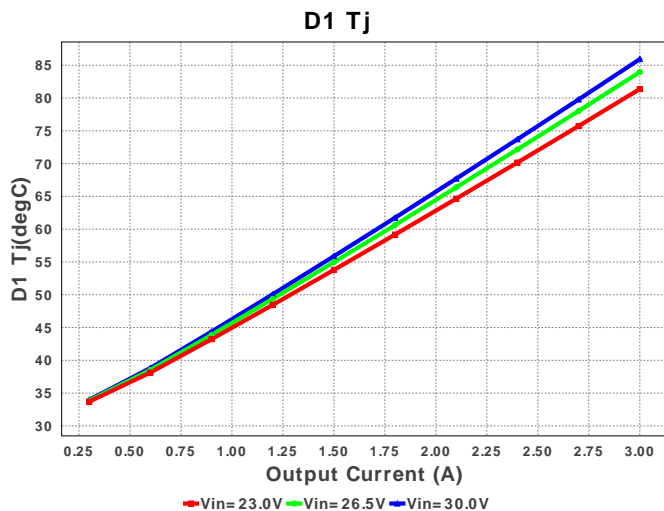
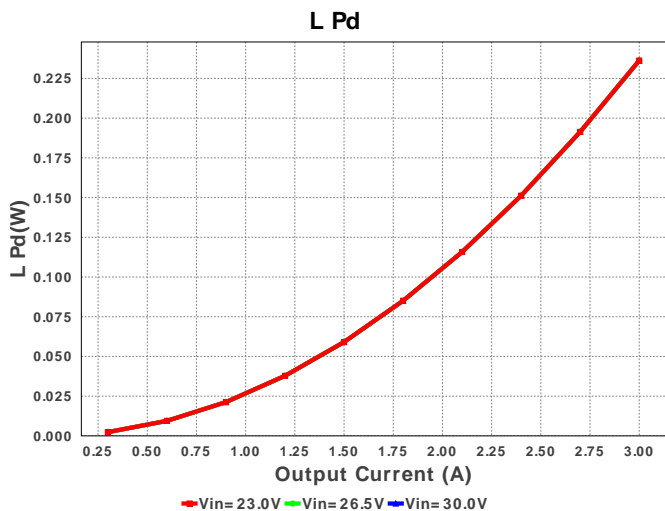


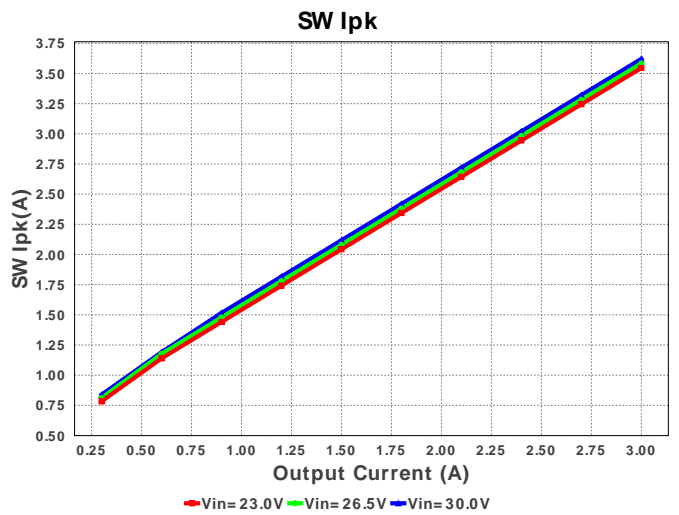
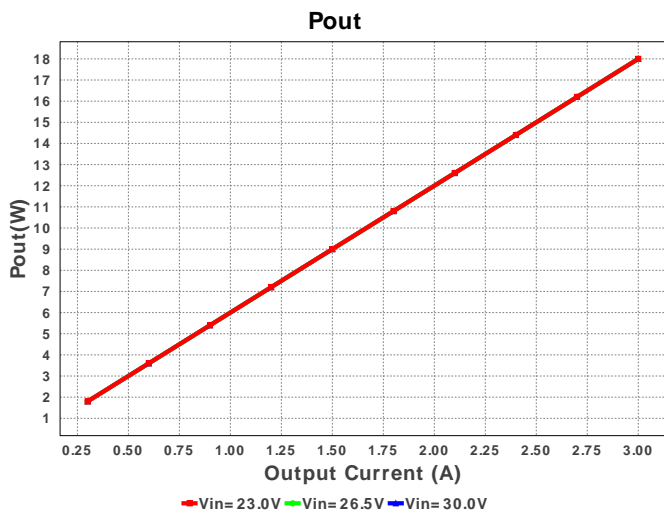
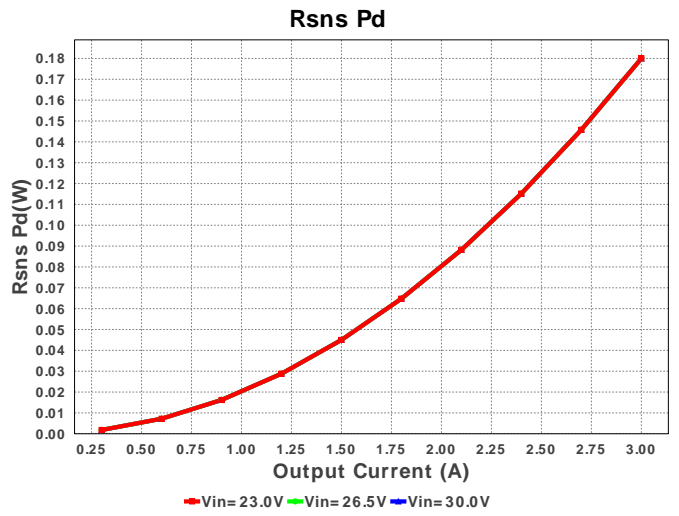
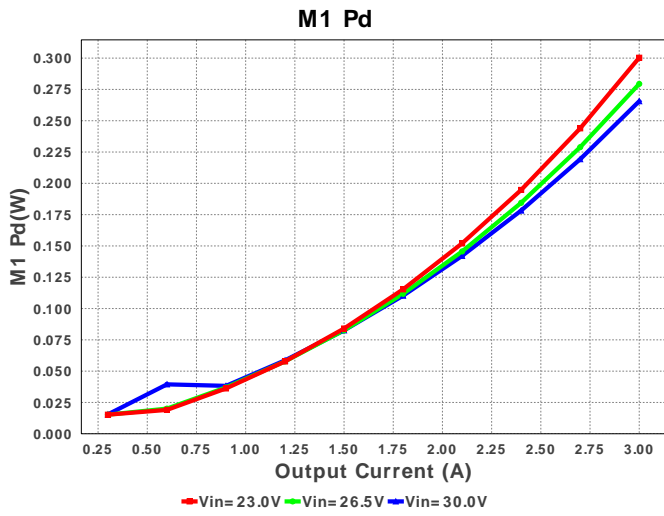
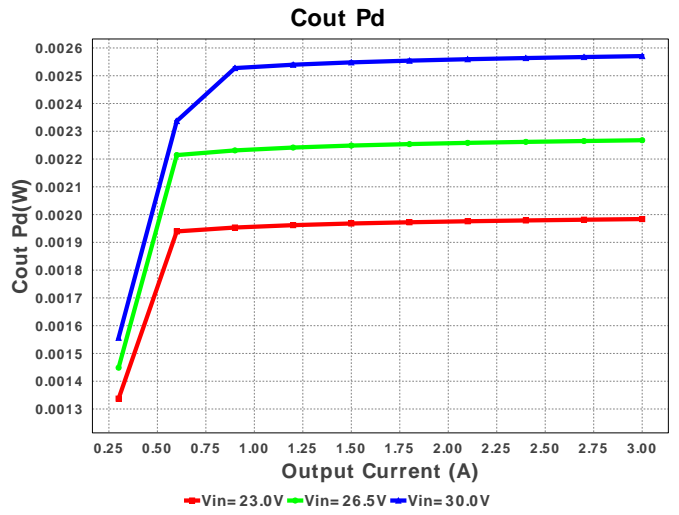
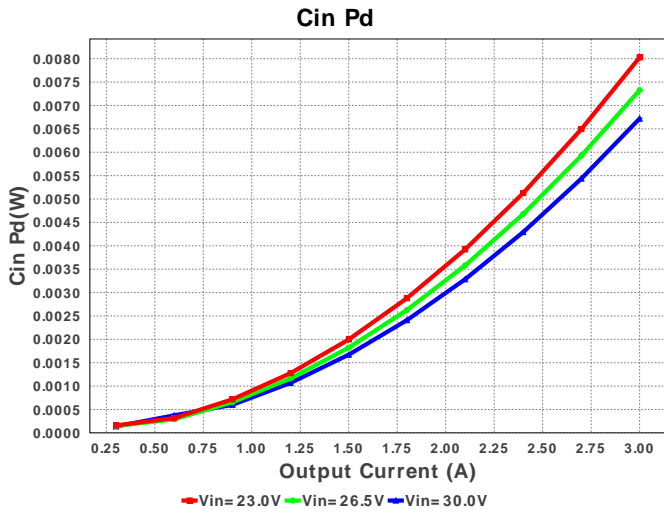
Duty Cycle

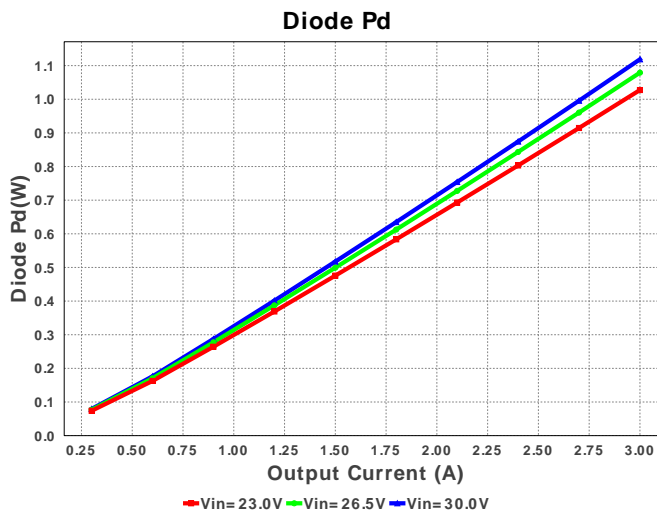
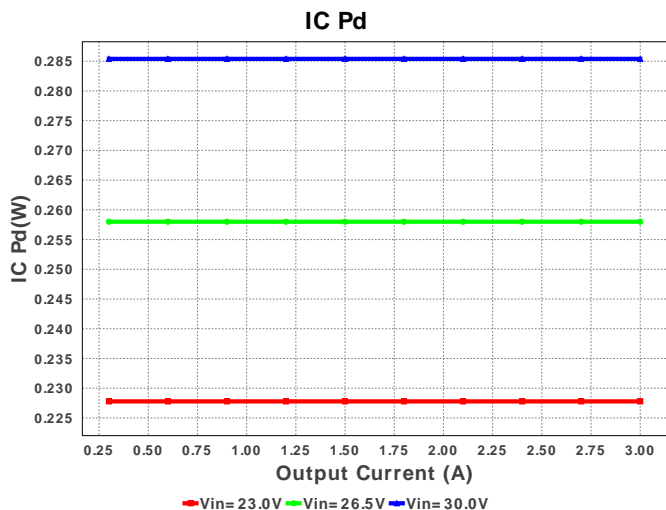
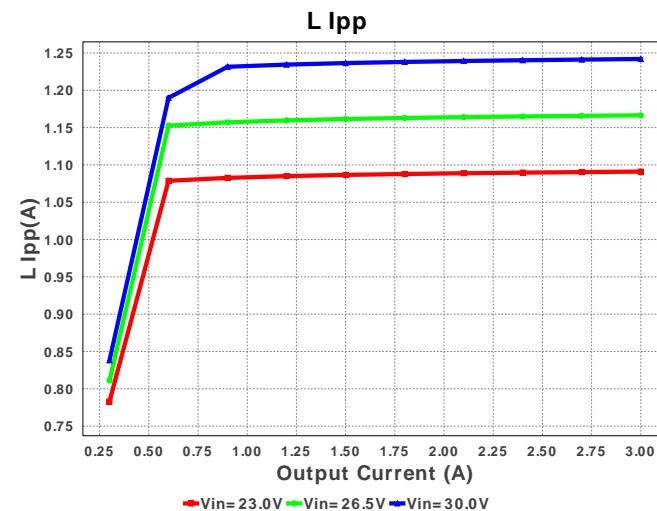
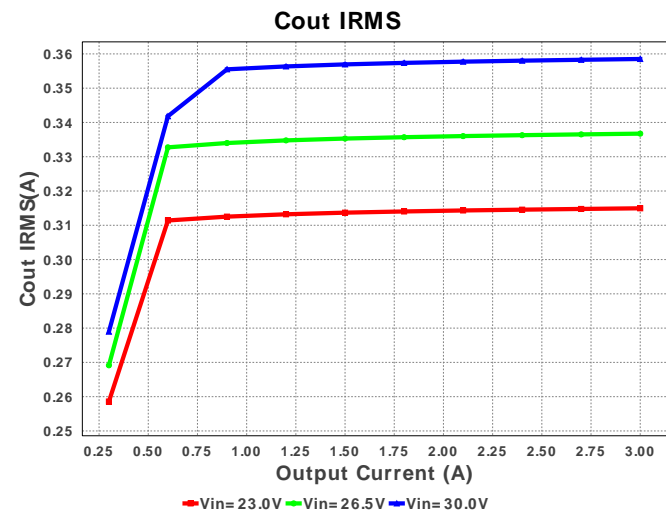
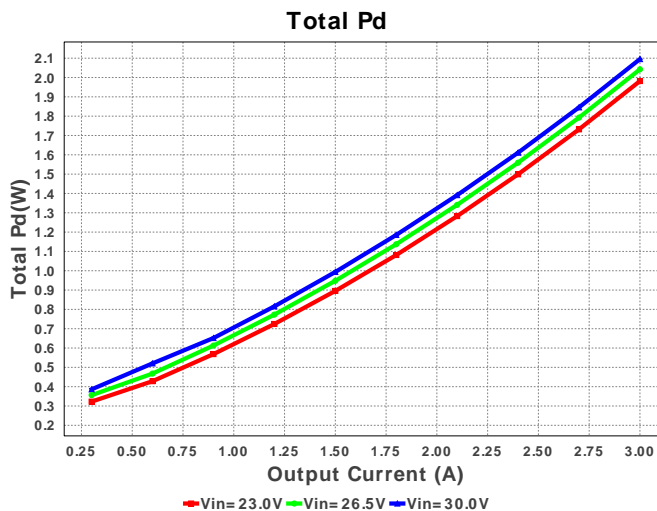
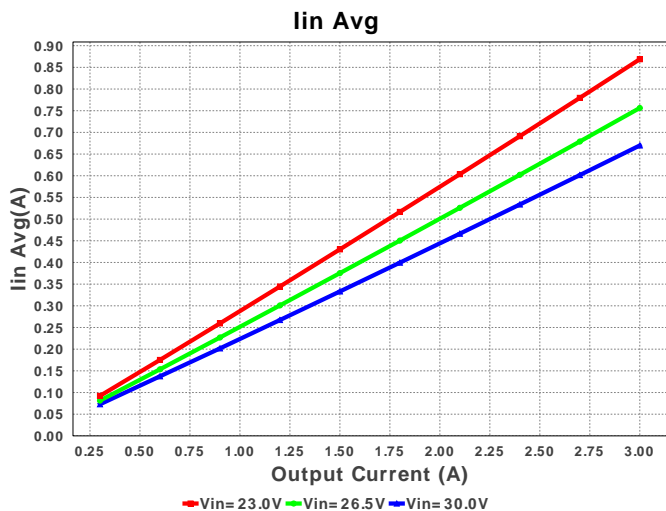


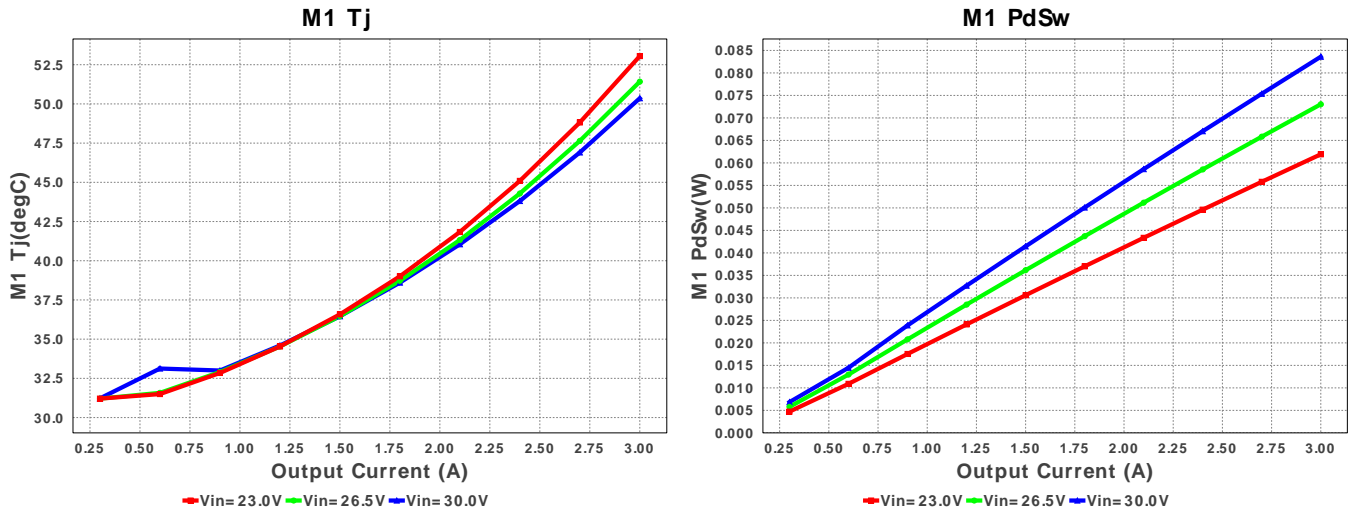
Cin IRMS











Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	1.229 A	Current	Input capacitor RMS ripple current
2.	Cout IRMS	386.364 mA	Current	Output capacitor RMS ripple current
3.	Iin Avg	669.21 mA	Current	Average input current
4.	L Ipp	1.338 A	Current	Peak-to-peak inductor ripple current
5.	SW Ipk	3.669 A	Current	Peak switch current
6.	BOM Count	12	General	Total Design BOM count
7.	FootPrint	499.0 mm ²	General	Total Foot Print Area of BOM components
8.	Frequency	436.364 kHz	General	Switching frequency
9.	IC Tolerance	0.0 V	General	IC Feedback Tolerance
10.	Mode	CCM	General	Conduction Mode
11.	Pout	18.0 W	General	Total output power
12.	Total BOM	\$2.08	General	Total BOM Cost
13.	D1 Tj	85.937 degC	Op_Point	D1 junction temperature
14.	Vout Actual	5.999 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
15.	Vout OP	6.0 V	Op_Point	Operational Output Voltage
16.	Duty Cycle	21.337 %	Op_point	Duty cycle
17.	Efficiency	89.658 %	Op_point	Steady state efficiency
18.	IC Tj	83.143 degC	Op_point	IC junction temperature
19.	ICThetaJA	200.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
20.	IOUT_OP	3.0 A	Op_point	Iout operating point
21.	M1 Tj	50.361 degC	Op_point	M1 MOSFET junction temperature
22.	VIN_OP	30.0 V	Op_point	Vin operating point
23.	Vout p-p	27.173 mV	Op_point	Peak-to-peak output ripple voltage
24.	Cin Pd	6.719 mW	Power	Input capacitor power dissipation
25.	Cout Pd	2.986 mW	Power	Output capacitor power dissipation
26.	D1 Pd	1.119 W	Power	Output Diode Power Dissipation
27.	Diode Pd	1.119 W	Power	Diode power dissipation
28.	IC Pd	265.714 mW	Power	IC power dissipation
29.	L Pd	236.25 mW	Power	Inductor power dissipation
30.	M1 Pd	265.861 mW	Power	M1 MOSFET total power dissipation
31.	M1 PdCond	182.258 mW	Power	M1 MOSFET conduction losses
32.	M1 PdSw	83.603 mW	Power	M1 MOSFET switching losses
33.	Rsns Pd	180.0 mW	Power	LED Current Rsns Power Dissipation
34.	Total Pd	2.076 W	Power	Total Power Dissipation
35.	Vout Tolerance	1.602 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	3.0	Maximum Output Current
2.	VinMax	30.0	Maximum input voltage
3.	VinMin	23.0	Minimum input voltage
4.	Vout	6.0	Output Voltage
5.	base_pn	LM3485	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. Outline The LM3485 is a hysteretic PFET controller. The hysteretic control architecture provides for a stable design without the use of a control loop. The switching frequency depends on the inductance value, output capacitor ESR, and the input voltage. Therefore depending on the chosen BOM, the frequency at different input voltages would vary.

2. **LM3485** Product Folder : <http://www.ti.com/product/LM3485> : contains the data sheet and other resources.

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